Hoang-Son Nguyen

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Research Interests

Deep representation learning methods guided by identifiability and robustness principle, to improve generalizability, interpretability, and steerability of deep learning systems (such as large language models)

Education

Oregon State University M.S. in Artificial Intelligence The Chinese University of Hong Kong (CUHK) B.Eng. in Artificial Intelligence, First Class Honours	Oct. 2024 – Mar. 2026 United States Sep. 2019 – Mar. 2024 Hong Kong
Work Experience	
Graduate Research Assistant	Oct. 2024 – Now
School of Electrical Engineering & Computer Science	United States
• Supervisor: Dr. Xiao Fu	
• Topics: Deep Representation Learning, Matrix Factorization	
Research Assistant	Apr. 2024 – Aug. 2024
Dept. of Systems Engineering & Engineering Management, CUHK	Hong Kong
• Supervisor: Dr. Hoi-To Wai	

• Topics: Graph Signal Processing, Graph Learning

PREPRINTS & PUBLICATIONS

- N., Hoi-To Wai "Robustness of Graph Learning Algorithms to Partially Observed Smooth Graph Signals", Preprint in preparation, 2025.
- N. and Hoi-To Wai, "On Detecting Low-Pass Graph Signals under Partial Observations," IEEE 13rd Sensor Array and Multichannel Signal Processing Workshop (SAM), 2024.
- N., Yiran He and Hoi-To Wai, "On the Stability of Low Pass Graph Filter with a Large Number of Edge Rewires," IEEE International Conference on Acoustics, Speech and Signal Processing (ICASSP), 2022.

HONORS & AWARDS (SELECTED)

Best Student Paper Award at IEEE SAM	2024
For the best student works at IEEE Sensor Array and Multichannel Signal Processing Workshop	
Professor Charles K. Kao Research Scholarship	2023
For outstanding achievements in undergraduate research	
University Admission Scholarship	2019
Full-ride scholarship for the entire undergraduate study	

MISCELLANEOUS

Programming: Python (PyTorch, PySpark), C/C++, MATLAB, Linux **Reviewer**: Causality and Large Models @ NeuRIPS (2024), IEEE ICASSP (2025), IEEE TSP (2025)